Electronic Paten	t App	lication Fee	Transm	ittal			
Application Number:	107	10786807					
Filing Date:	25-	25-Feb-2004					
Title of invention:	Me	Method for improving semiconductor wafer test accuracy					
First Named Inventor/Applicant Name:	Hu	Hui-Mei Chen					
Filer:	De	Dennis Alan Duchene/Tobi Herbert					
Attorney Docket Number:	085	085027-0106					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	810	810				
	Tot	940						